

2835A03-XXS05-2P-F16-EC-LX Datasheet

This 2835 LED Light Source is a high performance energy efficient device which can handle high thermal and high driving current. The small package outline and high intensity make it an ideal choice for LED panel light, LED bulb light, LED tube light, backlighting and etc.



The White Power LED is available in the range of color temperature from 2600K to 7000K.

This part has a foot print that is compatible to most of the same size LED in the market today.

FEATURES

- Available in Cool White, Neutral White and Warm White color
- ANSI-compatible chromaticity bins
- High luminous Intensity and high efficiency
- Low thermal resistance
- Long operation life
- Wide viewing angle at 120°
- Silicone encapsulation/
- Environmental friendly, RoHS compliance

APPLICATIONS

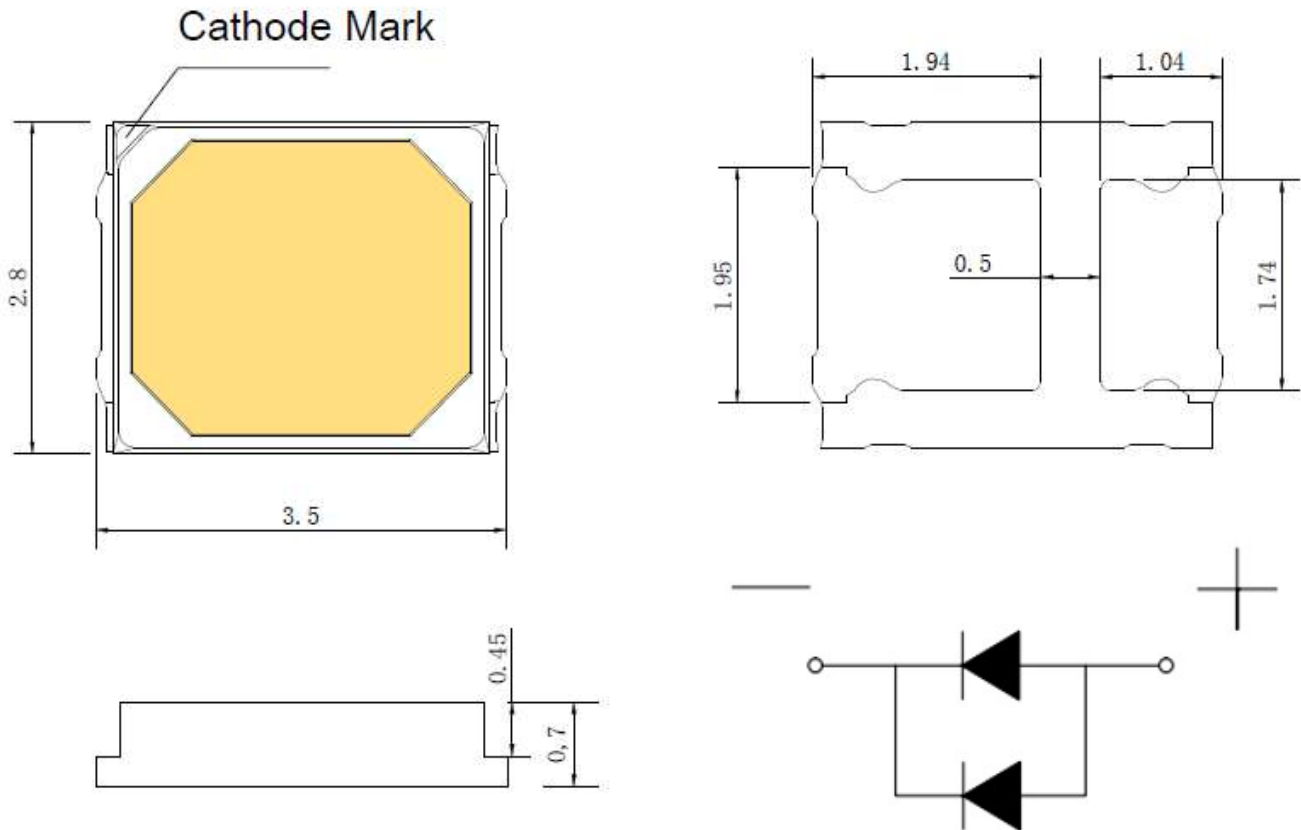
- Flat panel light
- LED tube light
- LED bulb light/
- Decorative and landscape lighting
- Signage and channel letter
- Reading lamp
- Table lamp

Note: The information in this document is subject to change without notice.

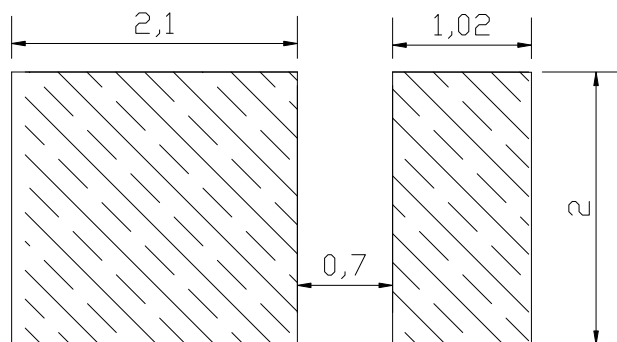
2835A03-XXS05-2P-F16-EC-LX

2835	A	03	XX	H	05	2P	Fx
Package size	LM-80 report type	voltage	CCT	Ra	power	quantity of chips	Program code
2835	A:General report	03: 3V	2700	L:<70	02 :0.2W	1S: 1 chip
3030			3000	N:>70	05 :0.5W	2S: 2 chips in series	
4014	B:Individual report	06: 6V	3500	H:>80	10 :1W	2P: 2 chips in parallel
5050			4000	S:>90	3S: 3 chips in series	
5630			5000	E:>95			
5730			5700				
		6000				
			6500				

PACKAGE DIMENSIONS



Recommended Solder Pad Design



Notes/ :

1. All dimensions in millimeters
2. Thickness tolerance of copper plate is ± 0.02 mm.
3. Thickness tolerance of product is ± 0.05 mm.
4. Tolerance is ± 0.1 mm unless otherwise noted.

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Forward current	IF	300	mA
Peak Forward Current	IFP	500	mA
Reverse Voltage	VR	5	V
Power Dissipation	Pd	500	mW
Operating Temperature	Topr	-40~+85	°C
Storage Temperature	Tstg	-40~+100	°C
Soldering Temperature	Tsld	Reflow Soldering: 260°C for 10 seconds	
LED Junction Temperature	Tj	115	°C

ELECTRO-OPTICAL CHARACTERISTICS (Ta=25°C)

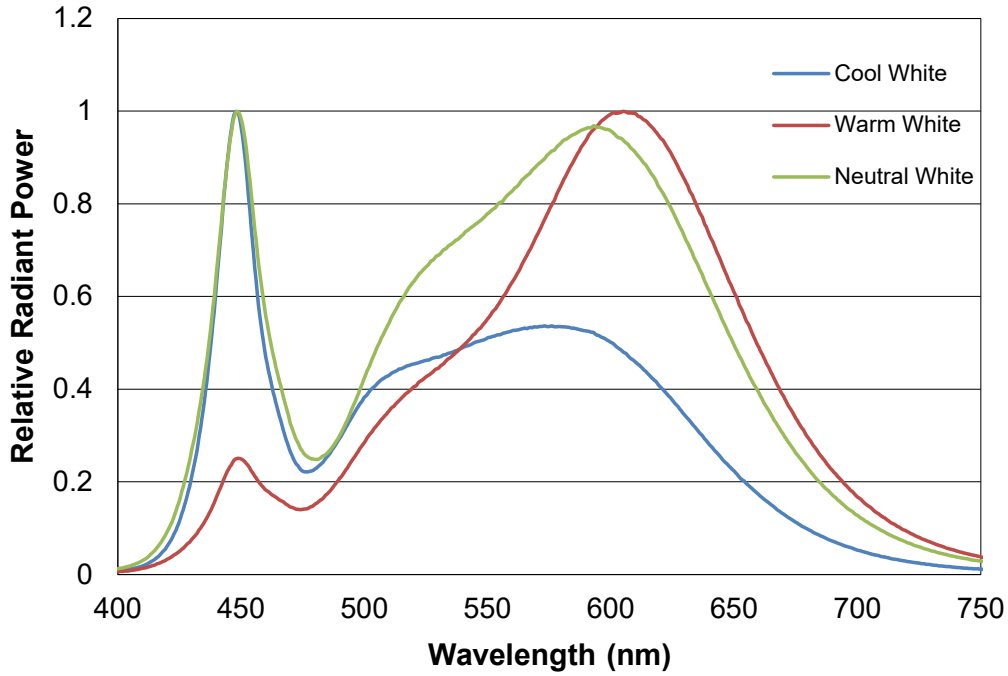
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Forward Voltage	V_F	IF=150mA	2.8	--	3.1	V
Viewing Angle	$2\theta_{1/2}$	IF=150mA	--	120	--	deg.
Luminous Flux	Φ_v	IF=150mA	55	--	70	lm
Color Rendering Index	CRI	IF=150mA	90	--	--	--
Color Temperature	CCT	IF=150mA	2600	--	7000	K
Thermal Resistance	R_{th-js}	IF=150mA	--	20	--	°C/W

Notes 注:

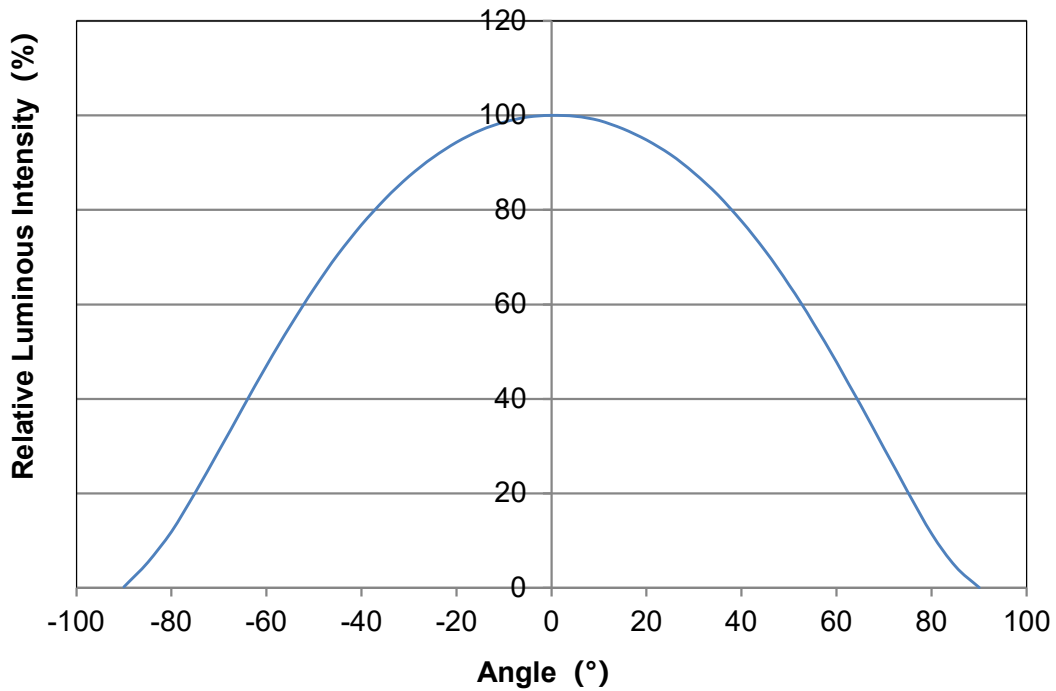
- Luminous flux is measured with an accuracy of $\pm 5\%$.
- Chromaticity coordinate bins are measured with an accuracy of ± 0.01 .
- CRI is measured with an accuracy of ± 2
- Some color and CRI bins may have limited availability, please contact us before ordering.
- All measurements were made under the standardized environment of Shineon

RELATIVE SPECTRAL POWER DISTRIBUTION ($T_j=25^\circ\text{C}$)

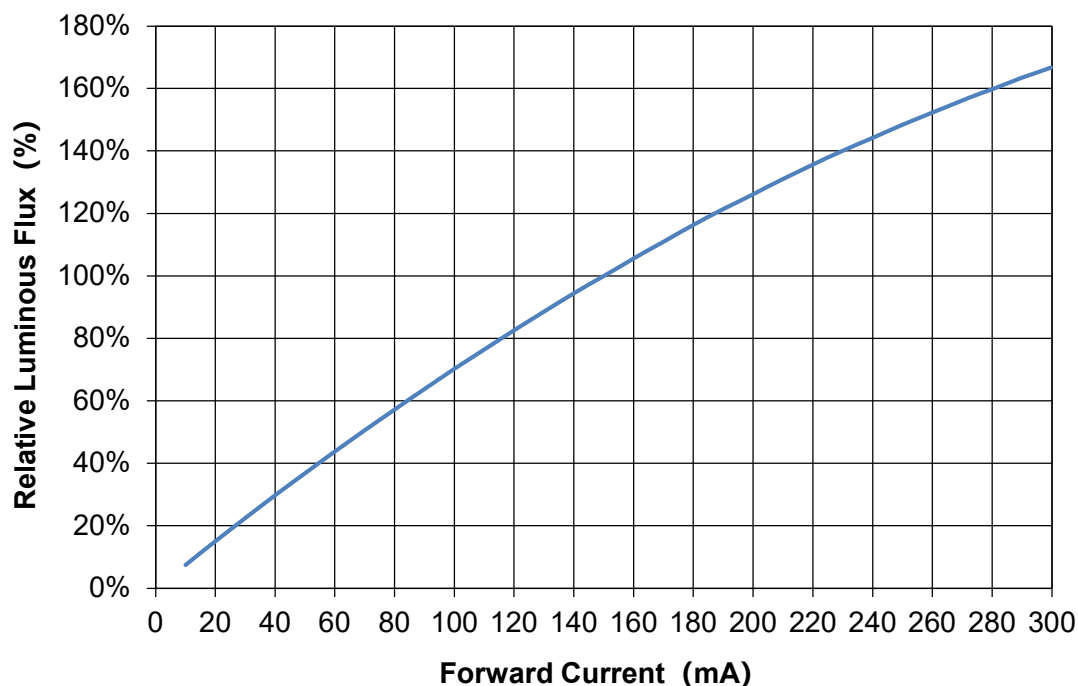
Spectrum Distribution



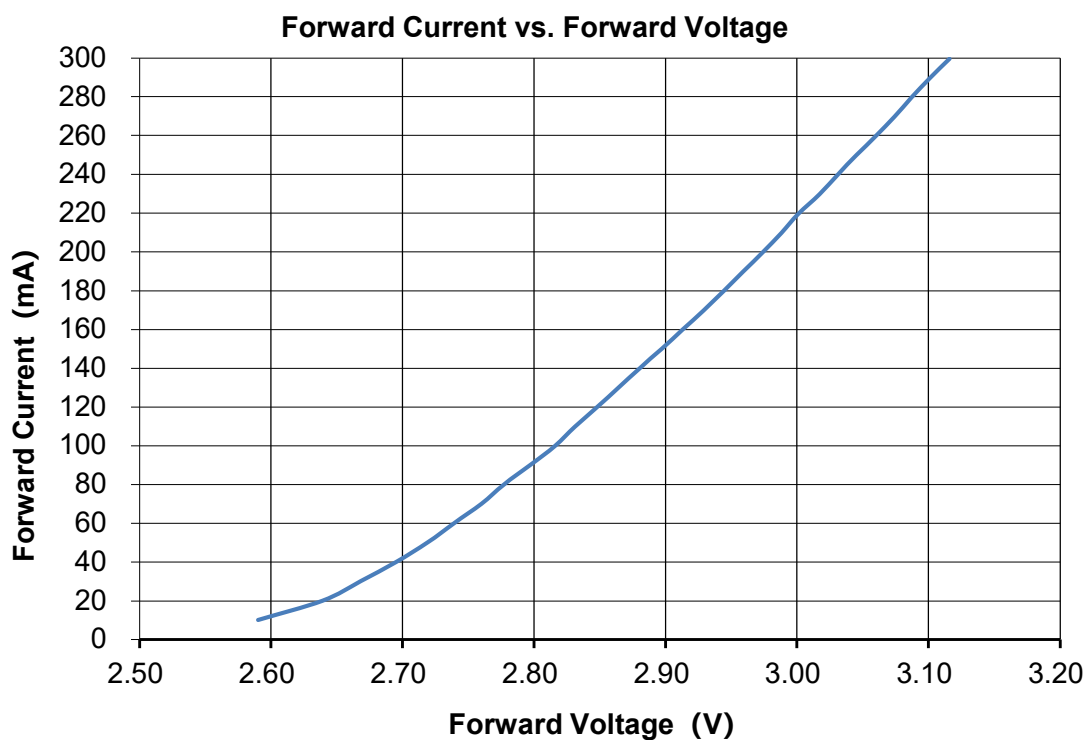
TYPICAL SPATIAL DISTRIBUTION



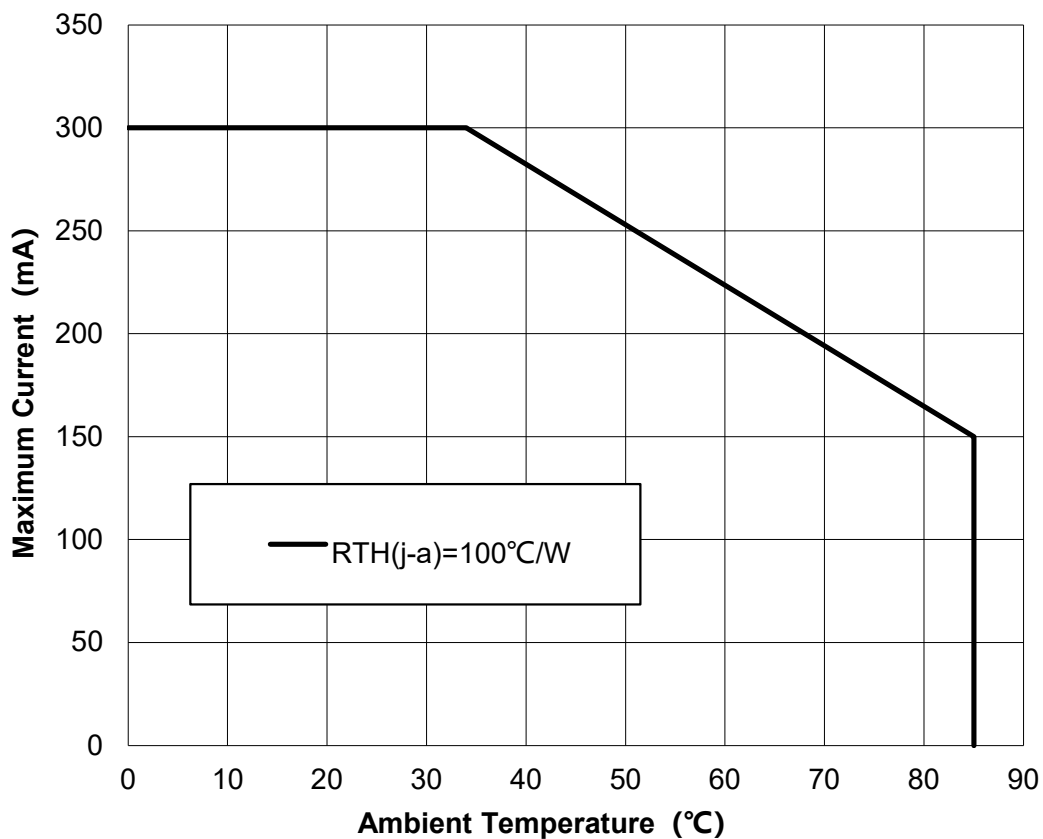
RELATIVE LUMINOUS FLUX VS. CURRENT ($T_j=25^\circ\text{C}$)



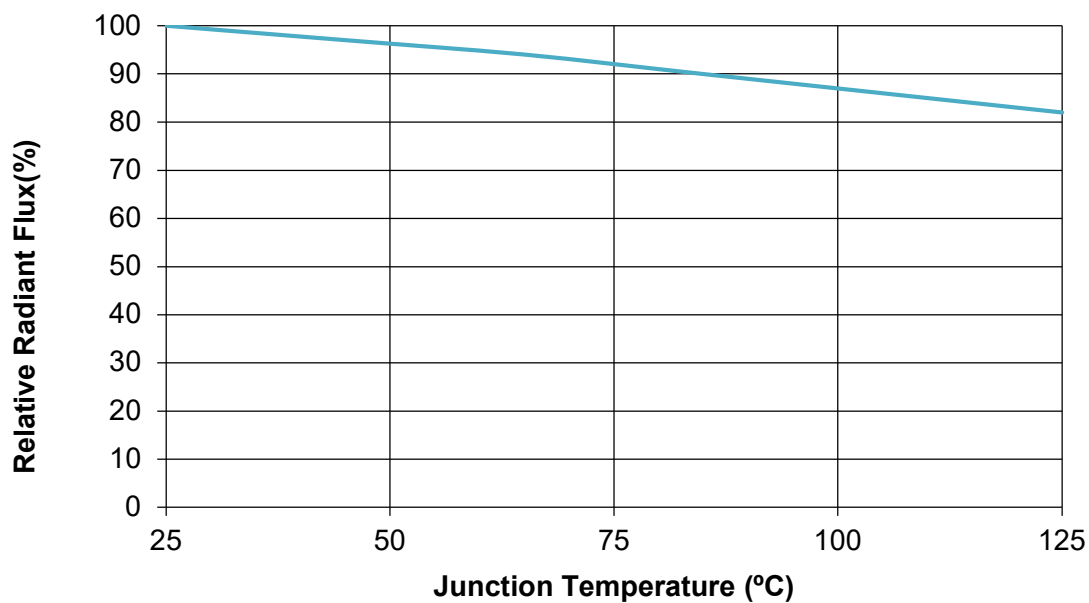
ELECTRICAL CHARACTERISTICS ($T_j=25^\circ\text{C}$)



MAXIMUM CURRENT VS. AMBIENT TEMPERATURE



RELATIVE RADIANT FLUX VS. JUNCTION TEMPERATURE



SORTING RANKS
(1) Luminous Flux T_j=25°C

Part Number	Condition	Rank	Unit
2835A03-27S05-2P-F16-EC-LX	150mA	P1	lm
		55-60	
2835A03-30S05-2P-F16-EC-LX		P2	
		60-65	
2835A03-35S05-2P-F16-EC-LX		P23	
		63-68	
2835A03-40S05-2P-F16-EC-LX		P3	
		65-70	
2835A03-50S05-2P-F16-EC-LX		P3	
		65-70	
2835A03-57S05-2P-F16-EC-LX	P3		
	65-70		
2835A03-65S05-2P-F16-EC-LX	P3		
	65-70		

(2) Forward Voltage T_j=25°C

Rank	Condition	Min.	Max.	Unit
A8	150mA	2.8	2.9	V
A9		2.9	3.0	
B0		3.0	3.1	

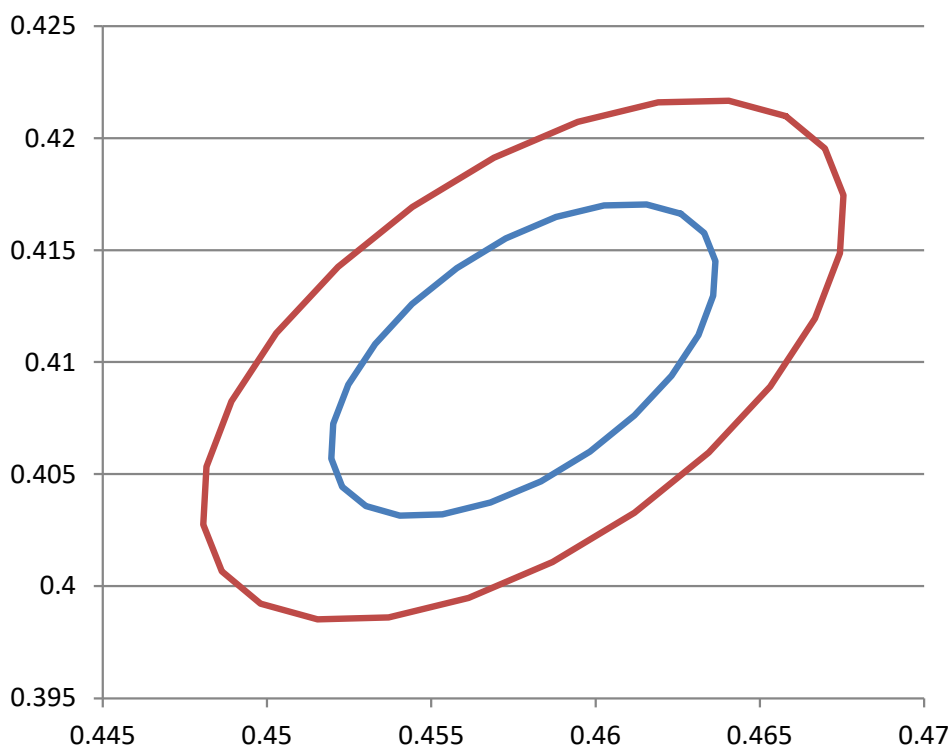
Notes 注：

1. 5% tolerance for luminous intensity may be caused by measurement inaccuracy.

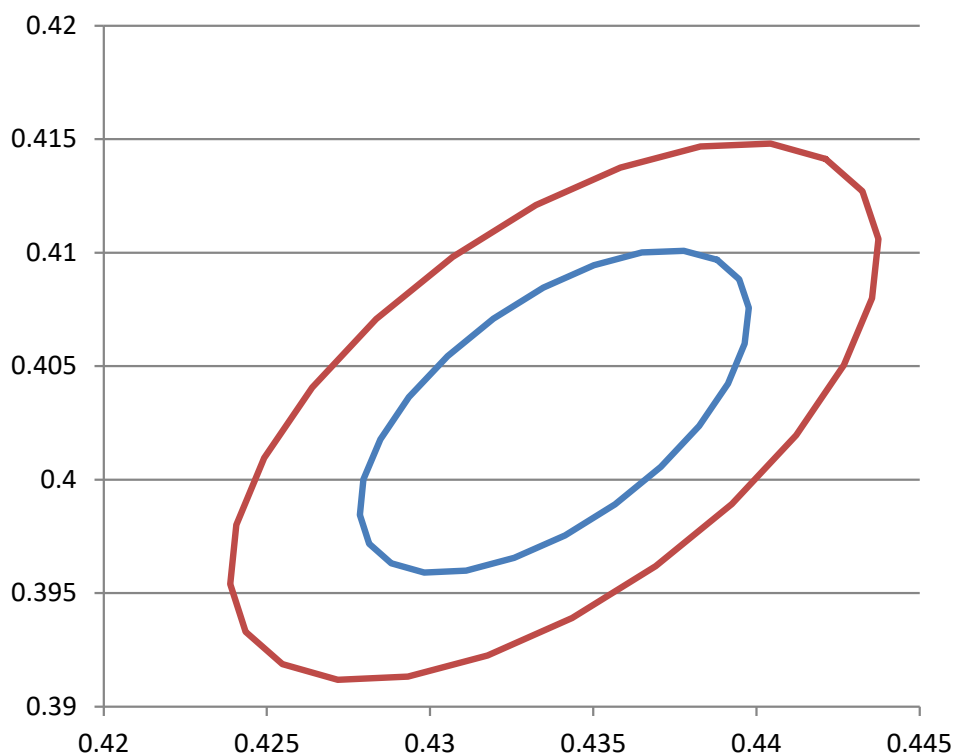
2. Measurement Uncertainty of the Forward Voltage : ± 0.1

(3) Chromaticity Bins

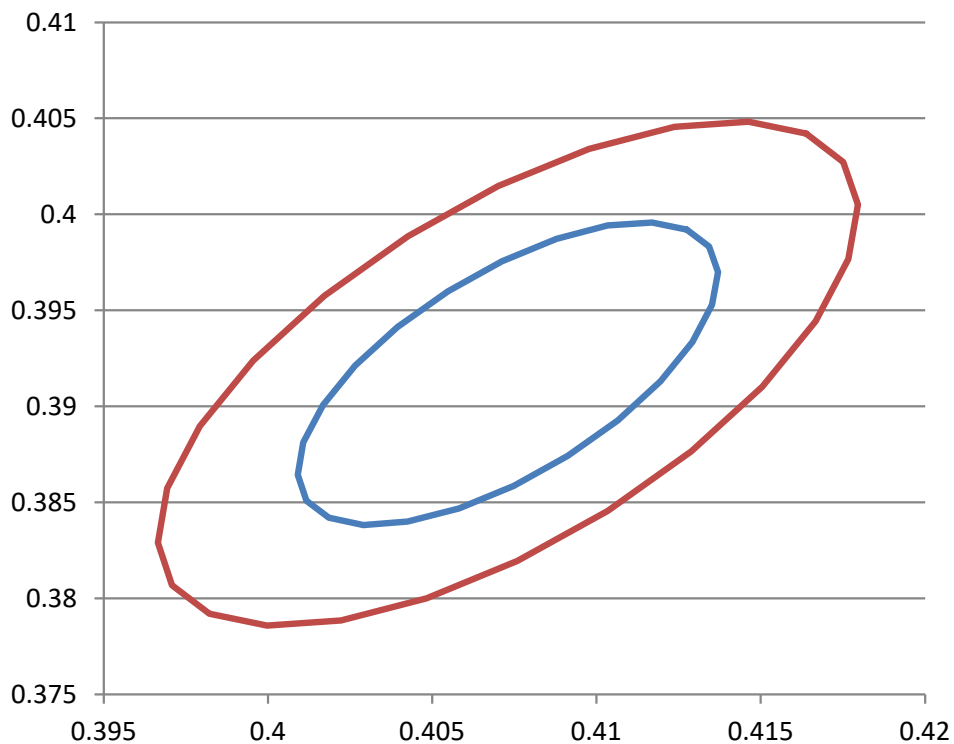
Part Number	2835A03-27S05-2P-F16-EC-LX			CCT	2700K
Bin Code	Color Coordinates(x,y)				
SDCM	x	y	a	b	Theta°
A27-3	0.4578	0.4101	0.00810	0.0042	53.7000
A27-5			0.01350	0.0070	



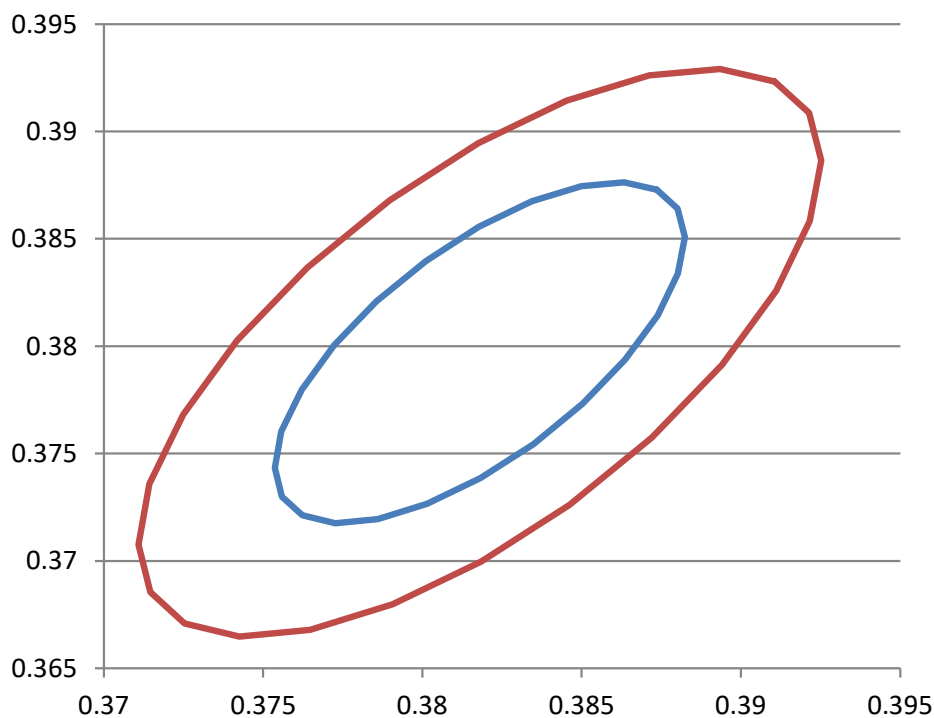
Part Number	2835A03-30S05-2P-F16-EC-LX			CCT	3000K
Bin Code	Color Coordinates(x,y)				
SDCM	x	y	a	b	Theta°
A30-3	0.4338	0.403	0.00834	0.00408	53.2200
A30-5			0.0139	0.0068	



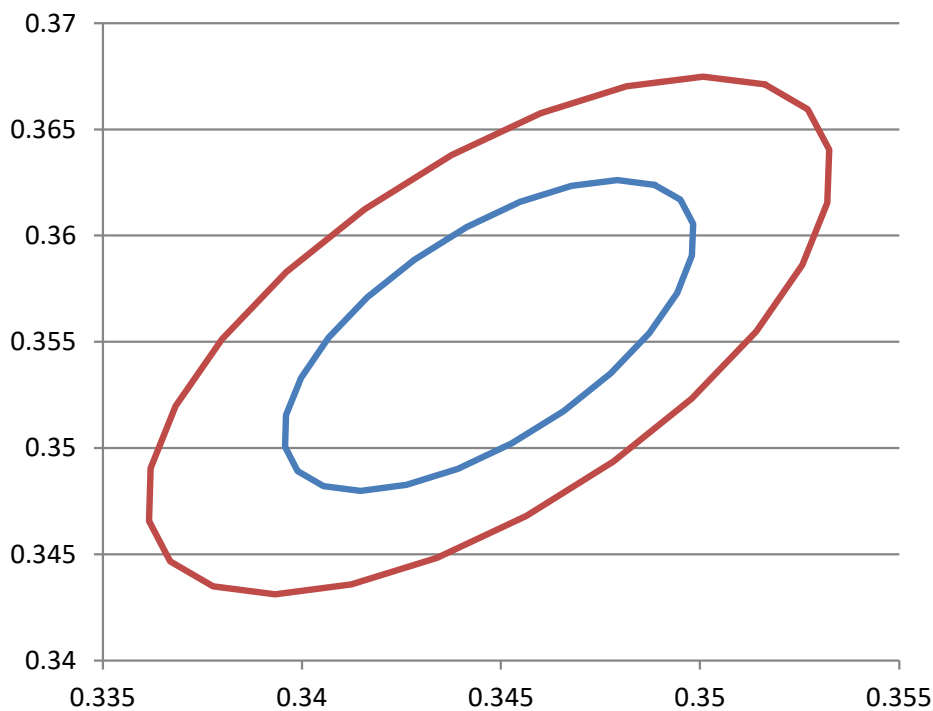
Part Number	2835A03-35S05-2P-F16-EC-LX			CCT	3500K
Bin Code	Color Coordinates(x,y)				
SDCM	x	y	a	b	Theta°
A35-3	0.4073	0.3917	0.00927	0.00414	54
A35-5			0.01545	0.0069	



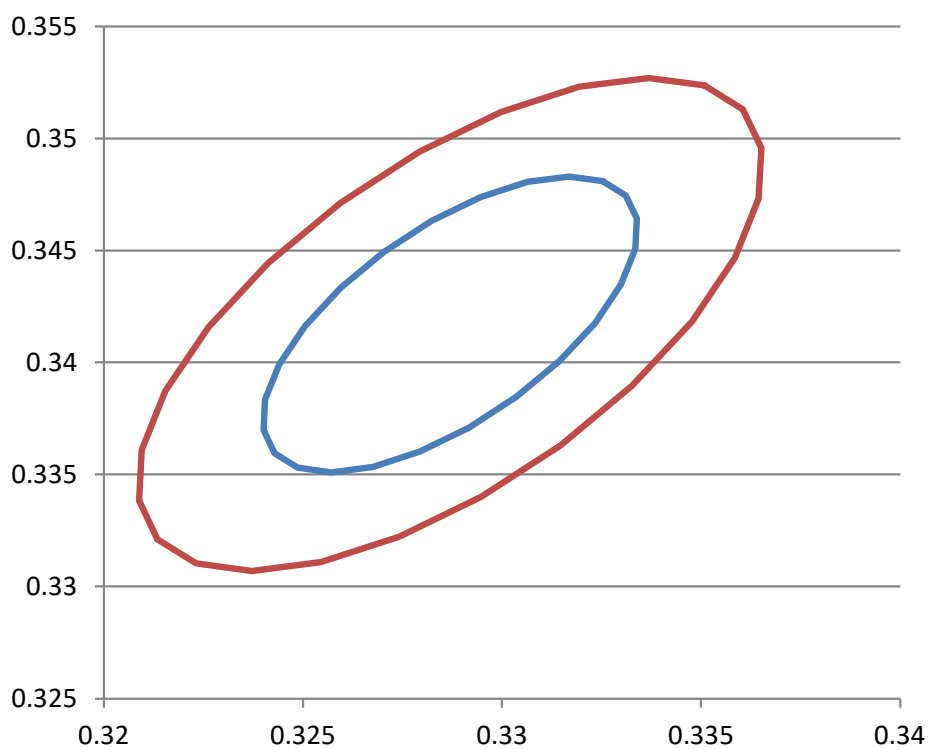
Part Number	2835A03-40S05-2P-F16-EC-LX				CCT	4000K
Bin Code	Color Coordinates(x,y)					
SDCM	x	y	a	b	Theta°	
A40-3	0.3818	0.3797	0.00939	0.00402	53.2200	
A40-5			0.01565	0.0067		



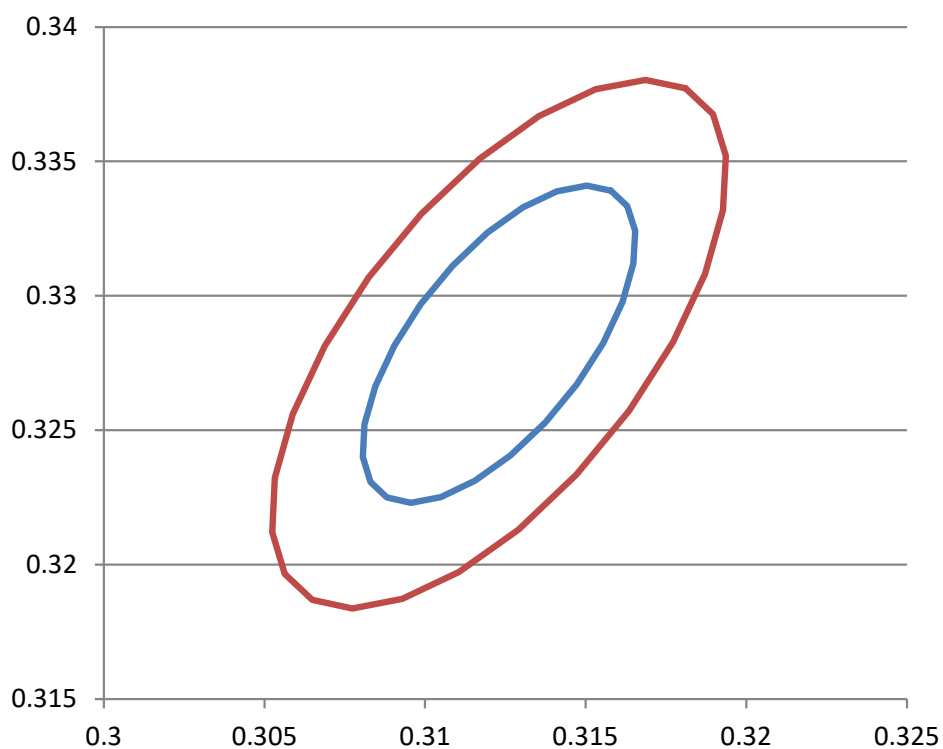
Part Number	2835A03-50S05-2P-F16-EC-LX				CCT	5000K
Bin Code	Color Coordinates(x,y)					
SDCM	x	y	a	b	Theta°	
A50-3	0.3447	0.3553	0.00822	0.00354	59.62	
A50-5			0.0137	0.0059		



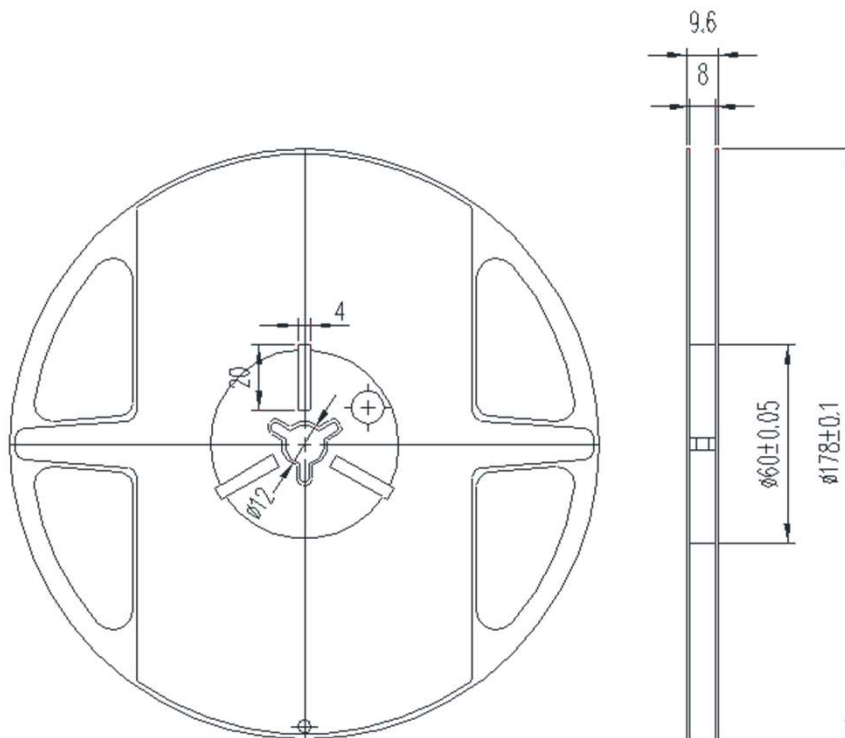
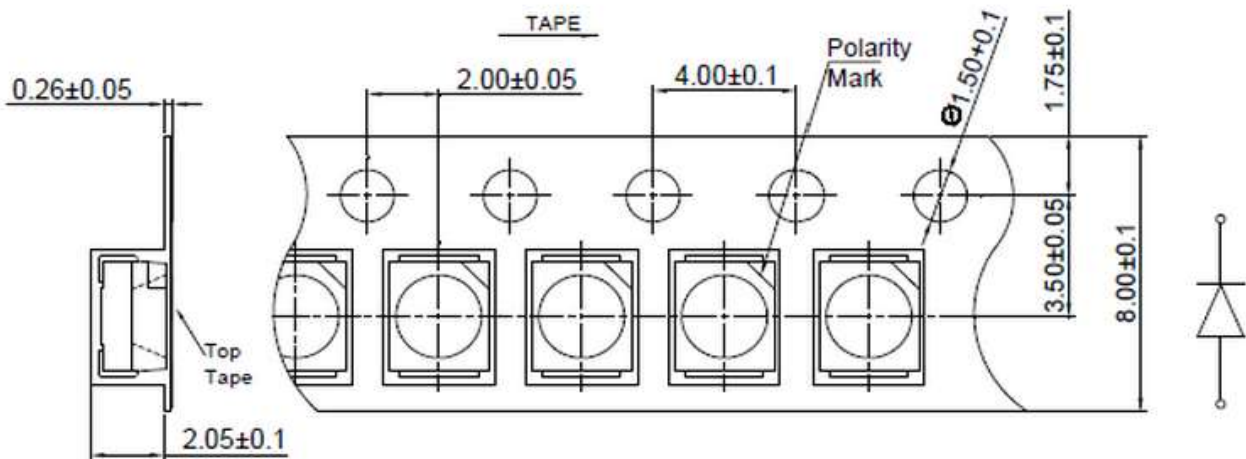
Part Number	2835A03-57S05-2P-F16-EC-LX				CCT	5700K
Bin Code	Color Coordinates(x,y)					
SDCM	x	y	a	b	Theta°	
A57-3	0.3287	0.3417	0.00746	0.00312	59.09	
A57-5			0.01243	0.00533		



Part Number	2835A03-65S05-2P-F16-EC-LX				CCT	6500K
Bin Code	Color Coordinates(x,y)					
SDCM	x	y	a	b	Theta°	
A65-3	0.3123	0.3282	0.00669	0.00285	58.57	
A65-5			0.01115	0.00475		



TAPE AND REEL








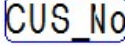
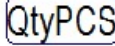


Note: The tolerances unless mentioned is ± 0.1 mm, Unit=mm

Notes注:

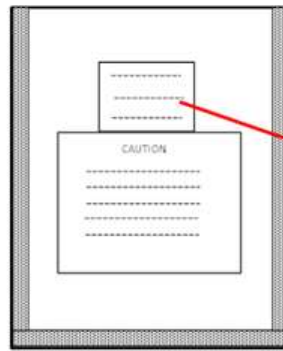
- (1) Quantity : 4,000pcs/Reel
- (2) Cumulative Tolerance : Cumulative Tolerance/10 pitches to be ± 0.2 mm
- (3) Adhesion Strength of Cover Tape : Adhesion strength to be 0.1-0.7N when the cover tape is turned off from the carrier tape at the angle of 10° to the carrier tape
- (4) Package : P/N, Manufacturing data Code No. and quantity to be indicated on a damp proof Package.

PACKAGING

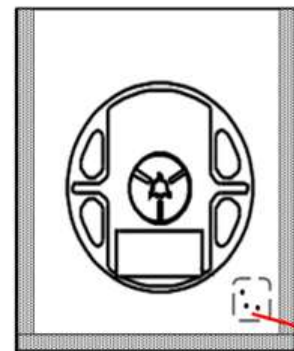
Name:	PrdtName	 
		
Lot NO:	LotNo	
		
BinCode:	BinCode	
		Prd No:  Cus No:  Quantity: 
IF:	IF	
VF:	VFV	
IV:	IVM	
RA:	RA	
CCT:	CCT	



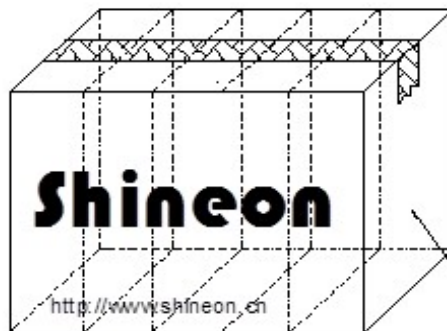
REEL



moisture-proof bag



desiccant



Outside box
Maximums 48 Reels

Reliability Test Items

Test Items 测试项目	Test Duration 测试时长	Number of Damaged 不良数
Steady State Operating Life of High Temperature (HTOL) $T_s=85^{\circ}\text{C}$, $I_F=\text{Max}$	1000hrs	0/20
Steady State Operating Life of Low Temperature (LTOL) $T_a=-40^{\circ}\text{C}$, $I_F=\text{Max}$	1000hrs	0/20
Pulse Wet Operating Life of High Temperature (PWHTOL) $60^{\circ}\text{C}/90\%\text{RH}$, $I_F30\text{mins ON}/30\text{min OFF}$	500hrs	0/20
High Temperature Storage (HTS) 100°C	1000hrs	0/20
Low Temperature Storage (LTS) -40°C	1000hrs	0/20
Thermal Shock (TS) $-45^{\circ}\text{C}\sim 125^{\circ}\text{C}$ 15min dwell 30sec transfer	100cycles	0/20
Solder Resistance (SR) 265°C , 3X MSL	5sec	0/20
Solder Ability (SA) $245^{\circ}\text{C}5\text{sec}$, 95% coverage	5sec	0/11

Item	Symbol	Test Condition	Criteria for Judgment	
			Min.	Max.
Forward Voltage	V_f	$I_F=\text{Typical Current}$		U.S.L x1.1
Luminous Flux	I_m	$I_F=\text{Typical Current}$	L.S.L x0.7	
CCX&CCY	x,y	$I_F=\text{Typical Current}$		Shift<0.02

REFLOW SOLDERING CHARACTERISTICS

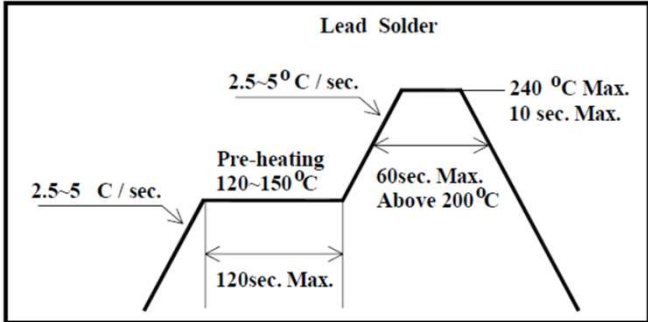
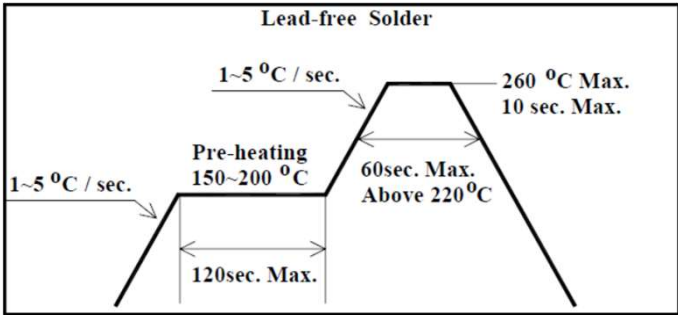
For Reflow Process :

Preheating : 140°C~160°C±5°C, within 2 minutes.

Operation heating: 260°C(Max.) within 10 seconds.(Max)

Gradual Cooling (Avoid quenching).

Lead solder		Lead-free solder	
Pre-heat	120-150°C	Pre-heat	150-200°C
Pre-heat time	120 sec.Max.	Pre-heat time	120 sec.Max.
Peak Temperature	240°C Max.	Peak Temperature	260°C Max.
Soldering time condition	10 sec.Max.	Soldering time condition	10 sec.Max.

Lead Solder	Lead-free Solder
 <p>The diagram shows a reflow profile for Lead Solder. It starts with a heating phase at 2.5~5 °C/sec. This is followed by a pre-heating phase at 120~150 °C for a maximum of 120 seconds. The temperature then rises to a peak of 240 °C at a rate of 2.5~5 °C/sec. The peak is maintained for a maximum of 10 seconds. The cooling phase occurs at a rate of 60sec. Max. Above 200 °C.</p>	 <p>The diagram shows a reflow profile for Lead-free Solder. It starts with a heating phase at 1~5 °C/sec. This is followed by a pre-heating phase at 150~200 °C for a maximum of 120 seconds. The temperature then rises to a peak of 260 °C at a rate of 1~5 °C/sec. The peak is maintained for a maximum of 10 seconds. The cooling phase occurs at a rate of 60sec. Max. Above 220 °C.</p>

Notes:

The encapsulated material of the LEDs is silicone . Therefore the LEDs have a soft surface on the top of package. The pressure to the top surface will be influence to the reliability of the LEDs. Precautions should be taken to avoid the strong pressure on the encapsulated part. So when using the picking up nozzle, the pressure on the silicone resin should be proper.

PRECAUTION FOR USE

- (1) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When washing is required, IPA should be used.
- (2) When the LEDs are illuminating, operating current should be decided after considering the ambient maximum temperature.
- (3) LEDs must be stored to maintain a clean atmosphere. If the LEDs are stored for 3 months or more after being shipped from ShineOn, a sealed container with a nitrogen atmosphere should be used for storage.
- (4) The LEDs must be used within seven days after opening the moisture proof packing. Repack unused Products with anti-moisture packing, fold to close any opening and then store in a dry place.
- (5) The appearance and specifications of the product may be modified for improvement without notice.
- (6) This LED is sensitive to the static electricity and surge. It is recommended to use a wrist Band or anti-electrostatic glove when handling the LEDs.
- (7) On manual soldering, a solder tip must be needed as grounded for usage. If over voltage which exceeds the absolute maximum rating is applied to LEDs, it will cause damage LEDs and result in destruction. Damaged LEDs will show some unusual characteristics such as leak current remarkably increase ,turn-on voltage becomes lower and the LEDs get unlighted at low current.